

**FTDI RoHS2 - 2011/65/EU & (EU) 2015/863**  
**Compliance Statement**

This document hereby certifies that the FTDI integrated circuit devices (with the exception listed in table 2) are in compliance with Directives 2011/65/EU and (EU) 2015/863 of the European Parliament on the restriction of the use of certain hazardous substances in electrical and electronic equipment (also known as "RoHS Recast"). In addition, this declaration of conformity is issued under the sole responsibility of FTDI. Specifically, products manufactured do not contain the substances listed in the table 1 in concentrations greater than the listed maximum value.

<b>Substance</b>	<b>Maximum Limit (ppm)</b>
Lead (Pb)	1000
Cadmium (Cd)	100
Mercury (Hg)	1000
Hexavalent Chromium (Cr6+)	1000
Poly Brominated Biphenyls (PBB)	1000
Poly Brominated Diphenyl ethers (PBDE)	1000
Bis(2-ethylhexyl) phthalate (DEHP)	1000
Butyl benzyl phthalate (BBP)	1000
Dibutyl phthalate (DBP)	1000
Diisobutyl phthalate (DIBP)	1000

Table 1

On behalf of Future Technology Devices International Ltd,



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**DISCLAIMER**

This declaration and its accuracy are made, solely based on available information and analytical data provided by our material suppliers.

**Non-Compliant Devices**



The following table shows devices which are not compliant with the RoHS directive, and their pin compatible equivalents:

Non-Compliant Device Part Numbers	RoHS Compliant, Pin Compatible Alternative
FT232BM	FT232BL
FT245BM	FT245BL
FT2232C	FT2232D
FT8U232AM	NOT AVAILABLE
FT8U245AM	NOT AVAILABLE
FT8U100AX	NOT AVAILABLE

Table 2

Full product details can be found in the individual device datasheets at [www.ftdichip.com](http://www.ftdichip.com)